

Features

- Split Gate Trench MOSFET Technology
- High Density Cell Design For Ultra Low $R_{DS(on)}$
- Moisture Sensitivity Level 1
- Halogen Free."Green"Device^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

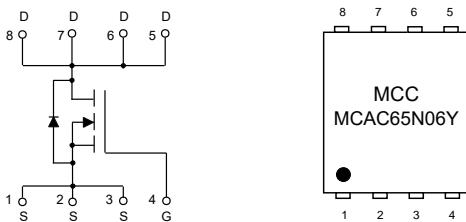
- Operating Junction Temperature Range : -55°C to +175°C
- Storage Temperature Range: -55°C to +175°C
- Thermal Resistance: 50°C/W Junction to Ambient^(Note2)
- Thermal Resistance: 1.5°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current $T_J=25^\circ\text{C}$	I_D	65	A
$T_J=100^\circ\text{C}$	I_D	46	
Pulsed Drain Current ^(Note3)	I_{DM}	260	A
Total Power Dissipation ^(Note4)	P_D	100	W
Single Pulse Avalanche Energy ^(Note 5)	E_{AS}	144	mJ

Note:

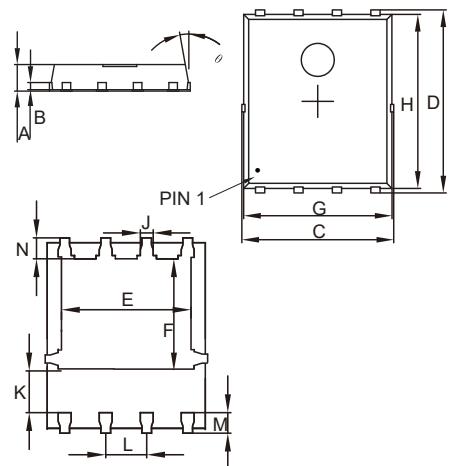
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R_{QJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-case thermal resistance.
5. $T_J=25^\circ\text{C}$, $V_{DD}=40\text{V}$, $R_G=25\Omega$, $L=1\text{mH}$.

Internal Structure and Marking Code



N-CHANNEL MOSFET

DFN5060

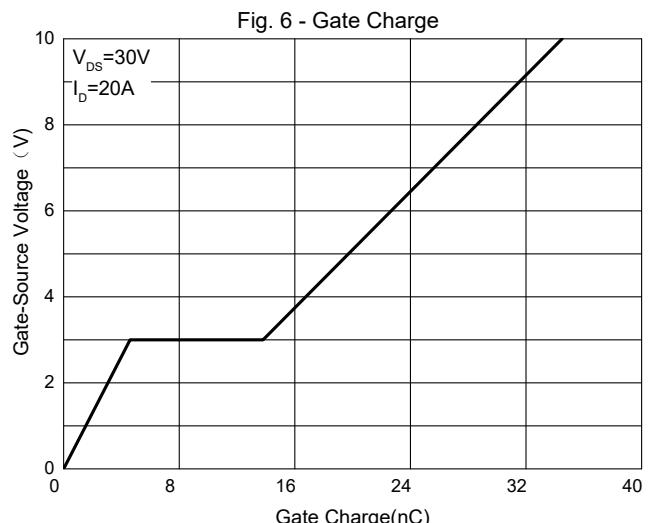
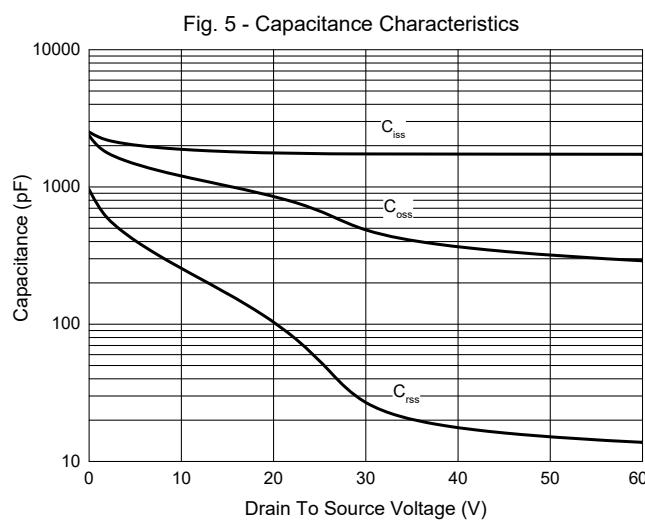
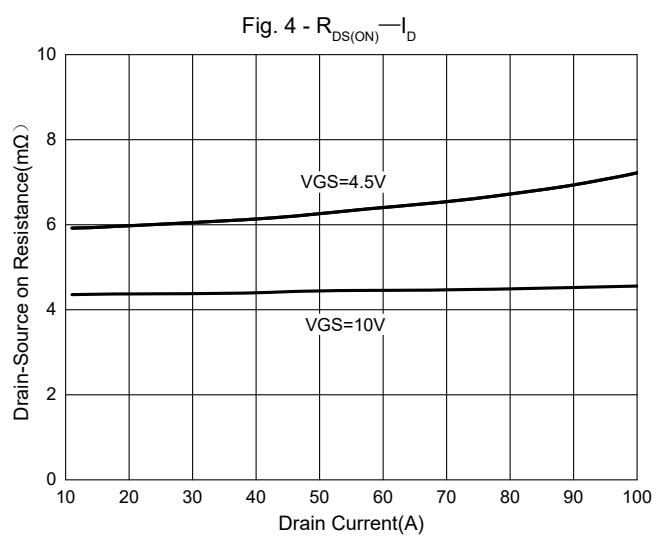
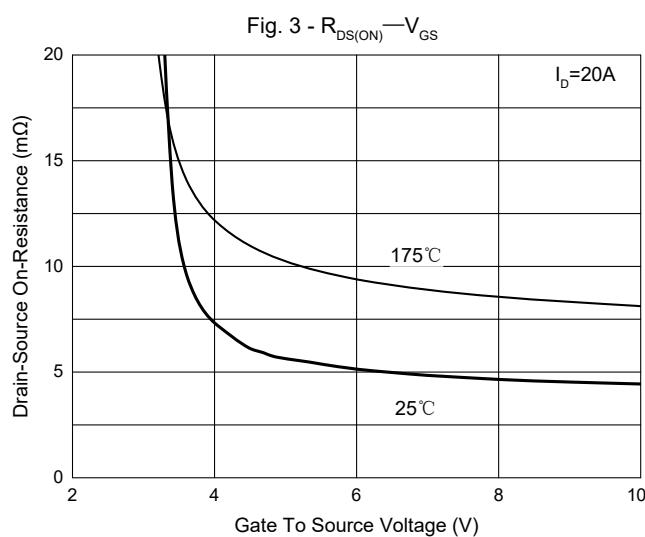
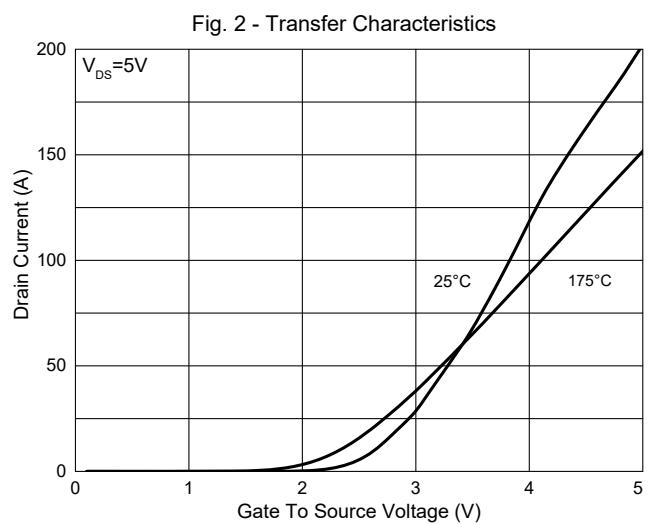
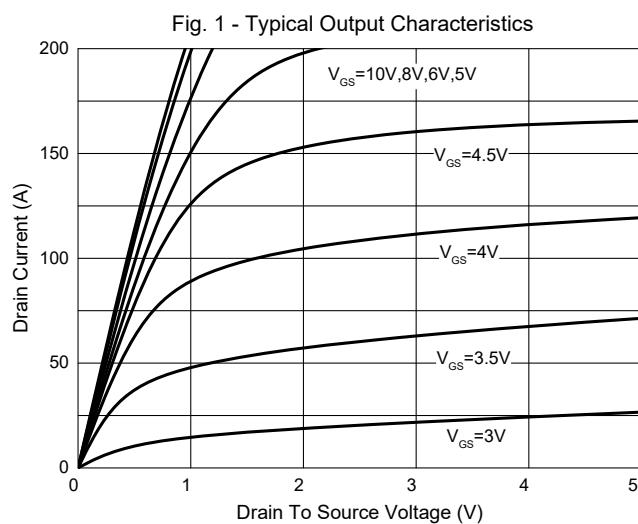


DIM	DIMENSIONS				NOTE	
	INCHES		MM			
	MIN	MAX	MIN	MAX		
A	0.031	0.047	0.80	1.20		
B	0.010		0.254		TYP.	
C	0.193	0.222	4.90	5.64		
D	0.232	0.250	5.90	6.35		
E	0.148	0.167	3.75	4.25		
F	0.126	0.154	3.20	3.92		
G	0.189	0.213	4.80	5.40		
H	0.222	0.239	5.65	6.06		
K	0.045	0.059	1.15	1.50		
J	0.012	0.020	0.30	0.50		
L	0.046	0.054	1.17	1.37		
M	0.012	0.028	0.30	0.71		
N	0.016	0.028	0.40	0.71		

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.6	2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		4.4	5.7	$m\Omega$
		$V_{GS}=4.5V, I_D=20A$		6.0	7.8	
Gate Resistance	R_g	F=1 MHz, Open drain		1.6		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				65	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=20A$			1.3	V
Reverse Recovery Time	t_{rr}	$I_F=20A, dI_F/dt=100A/\mu s$		37		ns
Reverse Recovery Charge	Q_{rr}			32		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V, f=1MHz$		1740		pF
Output Capacitance	C_{oss}			486		
Reverse Transfer Capacitance	C_{rss}			27		
Total Gate Charge	Q_g	$V_{DS}=30V, V_{GS}=10V, I_D=20A$		34.5		nC
Gate-Source Charge	Q_{gs}			4.6		
Gate-Drain Charge	Q_{gd}			9.2		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=30V, V_{GS}=10V, I_{DS}=10A, R_{GEN}=3\Omega$		8.9		ns
Turn-On Rise Time	t_r			10.6		
Turn-Off Delay Time	$t_{d(off)}$			29.5		
Turn-Off Fall Time	t_f			12.4		

Curve Characteristics



Curve Characteristics

Fig. 7 - Normalized Threshold Voltage

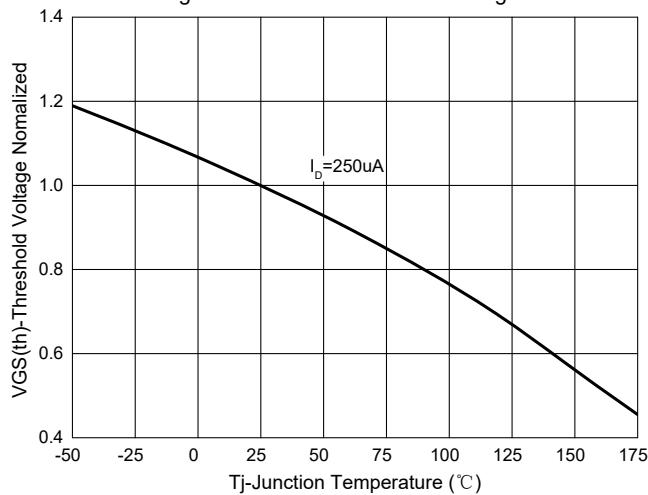


Fig.8-Normalized On Resistance Characteristics

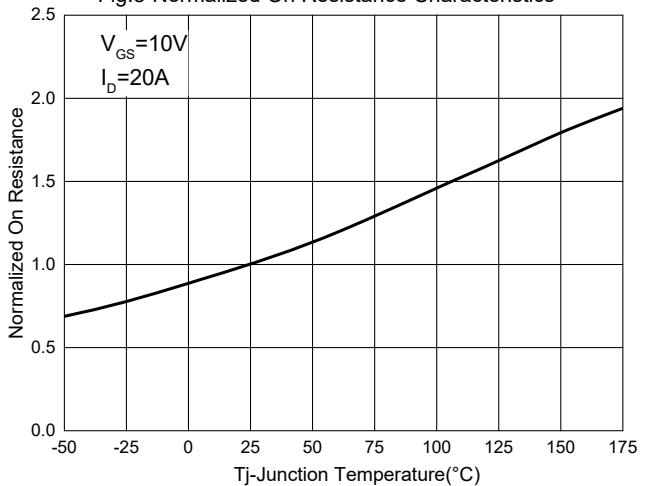


Fig.9 - I_s — V_{SD}

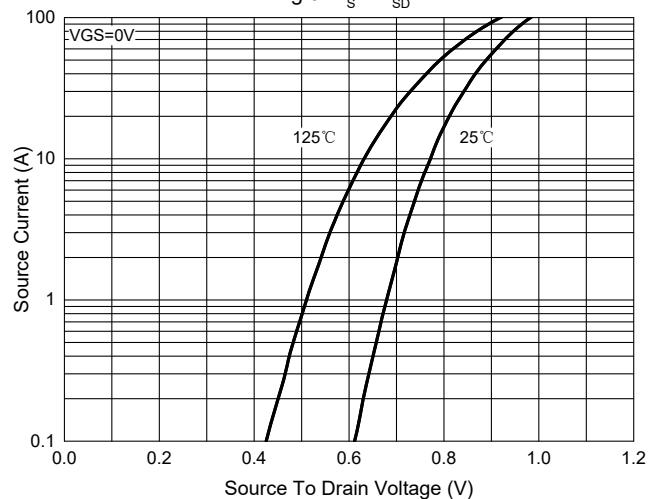


Fig. 10 - Drain Current

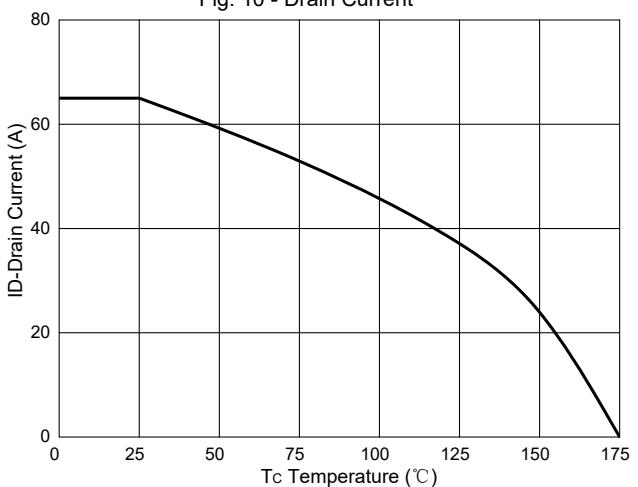
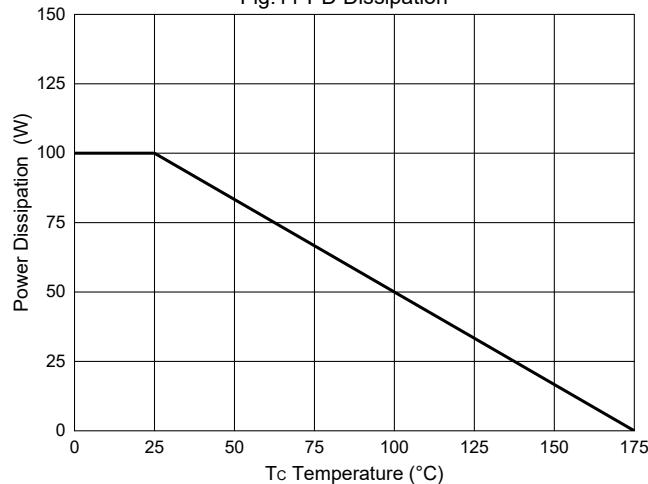
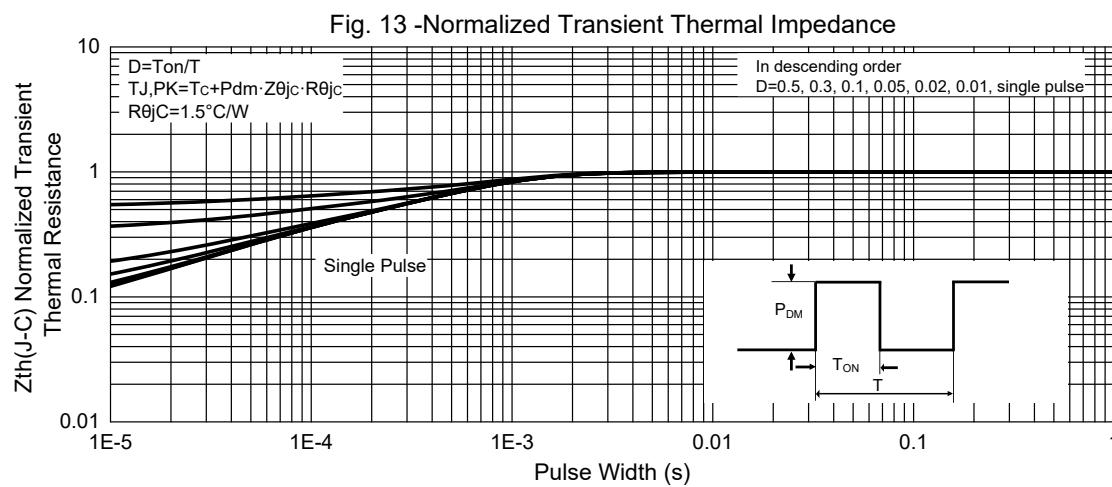
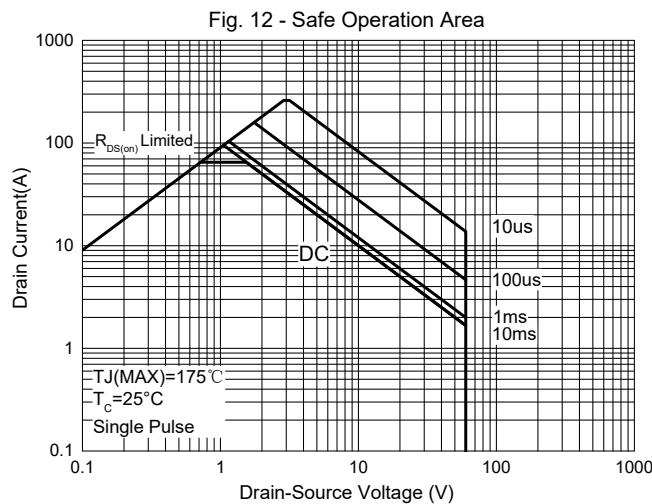


Fig.11-PD Dissipation



Curve Characteristics



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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